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TID #: TIDA-01366

## TEXAS INSTRUMENTS

## **TIDA-01366 REV E1 Bill of Materials**

Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	!PCB	1		TIDA-01366	Any	Printed Circuit Board	
2	C1	1	47uF	TPSB476K010R0250	AVX	CAP, TA, 47 µF, 10 V, +/- 10%, 0.25 ohm, SMD	3528-21
3	C11, C12, C21,	11	22uF	C2012X7S1A226M125AC	TDK	CAP, CERM, 22 μF, 10 V, +/- 20%, X7S, 0805	0805
	C22, C31, C32,						
	C35, C36, C39,						
	C42, C44						
4	C13, C23, C33	3	0.022uF	GRM155R71C223KA01D	MuRata	CAP, CERM, 0.022 µF, 16 V, +/- 10%, X7R, 0402	0402
5	C16, C26, C28,	6	0.1uF	GRM155R71A104KA01D	MuRata	CAP, CERM, 0.1 µF, 10 V, +/- 10%, X7R, 0402	0402
	C40, C43, C45						
6	C27	1	10uF	GRM188Z71A106MA73D	MuRata	CAP, CERM, 10 µF, 10 V, +/- 20%, X7R, 0603	0603
7	C34	1	2700pF	GRM155R71H272KA01D	MuRata	CAP, CERM, 2700 pF, 50 V, +/- 10%, X7R, 0402	0402
8	C46	1	1uF	GRM155R70J105MA12D	MuRata	CAP, CERM, 1 µF, 6.3 V, +/- 20%, X7R, 0402	0402
9	FB21, FB31,	3	10 ohm	BLM15AX100SN1D	MuRata	Ferrite Bead, 10 ohm @ 100 MHz, 1.74 A, 0402	0402
	FB32						
10	J1, J11, J21, J22,	7		TSW-106-07-G-S	Samtec	Header, 100mil, 6x1, Gold, TH	6x1 Header
	J31, J32, J33						
11	JP1	1		TSW-103-07-T-S	Samtec	Header, 2.54 mm, 3x1, Tin, TH	Header, 2.54 mm,
							3x1. TH
12	JP2	1		TSW-102-07-T-S	Samtec	Header, 2.54 mm, 2x1, Tin, TH	Header, 2.54 mm,
						,,,,,,	2x1. TH
13	L11, L21	2	1uH	XFL4020-102MEB	Coilcraft	Inductor, Shielded, Composite, 1 µH, 5.4 A, 0.01 ohm, SMD	4x2x4mm
	L31, L32	2	470nH	XFL4015-471MEC	Coilcraft	Inductor, Shielded, Composite, 470 nH, 3.5 A, 0.0076 ohm, SMD	SMD, 4x4x1.5mm
	R11	1	17.4k	CRCW040217K4FKED	Vishay-Dale	RES, 17.4 k, 1%, 0.063 W, 0402	0402
	R12, R22, R31,	4	20.0k	CRCW040220K0FKED	Vishay-Dale	RES, 20.0 k, 1%, 0.063 W, 0402	0402
	R32		201011	0.101101022011011122	rionay baic	1, 20, 20,0 k, 170, 0,000 k, 0,002	0.02
	R13, R23, R33,	4	100k	CRCW0402100KJNED	Vishay-Dale	RES, 100 k, 5%, 0.063 W, 0402	0402
	R34		TOOK	ONO TO TO TO TO TO TO TO	Violity Bale	1120, 100 K, 070, 0.000 W, 0402	0.102
	R14, R24	2	8.2k	CRCW04028K20JNED	Vishay-Dale	RES, 8.2 k, 5%, 0.063 W, 0402	0402
	R21	1	42.2k	CRCW040242K2FKED	Vishay-Dale	RES, 42.2 k, 1%, 0.063 W, 0402	0402
	SH-JP1, SH-JP2	2	1x2	969102-0000-DA	3M	Shunt, 100mil, Gold plated, Black	Shunt
	TP11, TP12,	8	IXE	5002	Keystone	Test Point, Miniature, White, TH	White Miniature
21	TP21, TP22,	"		3002	Reystone	rest Form, Williature, Write, 111	Testpoint
	TP31, TP32,						Tootpoint
	TP33, TP34						
22	TP35	1		5000	Keystone	Test Point, Miniature, Red, TH	Red Miniature
22	11 33	'		3000	Reystone	Tost Form, Williadure, Neu, 111	Testpoint
23	TP36	1		5001	Keystone	Test Point, Miniature, Black, TH	Black Miniature
20	11 30	'		3001	Reystone	Test Form, Williature, Diack, 111	Testpoint
24	U11, U21	2		TPS62097RWKR	Texas Instruments	2-A Step Down Converter with Selectable Switching Frequency in	RWK0011B
24	011, 021			11 302097 KWKK	Texas instruments	HotRod package, RWK0011B (VQFN-HR-11)	KWKOOTID
25	U31	1		TPS62480RNCR	Texas Instruments	6A, 5.5Vin, 2-Phase Step-Down Converter, RNC0016A (VQFN-HR-16)	RNC0016A
	U32	1		TPS22925CYPHR	Texas Instruments	3.6V. 3A. 9mΩ Load Switch with Reverse Current Protection and	YPH0006ACAC
20	002			11 022923011111	TOAGS INSTITUTIONS	Optional Quick Output Discharge, YPH0006ACAC (DSBGA-6)	TTTIOUULACAC
27	C2	0	47uF	TPSB476K010R0250	AVX	CAP, TA, 47 μF, 10 V, +/- 10%, 0.25 ohm, SMD	3528-21
	C14, C15, C24,	0	22uF	C2012X7S1A226M125AC	TDK	CAP, CERM, 22 µF, 10 V, +/- 10%, 0.23 01111, SMD	0805
	C14, C15, C24, C25, C37, C38		ZZUI	OZU IZA U IAZZUWI IZSAU	TOR.	Ο/ΛΙ , OLINN, 22 μΙ , 10 V, τ/- 20 /0, ΛΙ Ο, 0000	0000
	FID1, FID2, FID3	0		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	N/A
23	1 101, 1 102, 1 103		ļ.	list.	13/73	i iddeidi maik. Mele is nothing to buy of mount.	1.4/7.

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